

MME 345
Lecture **B:04**

Solidification and Crystallisation

3. Solidification of metals and alloys

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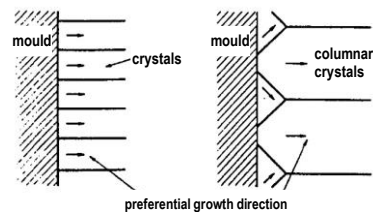
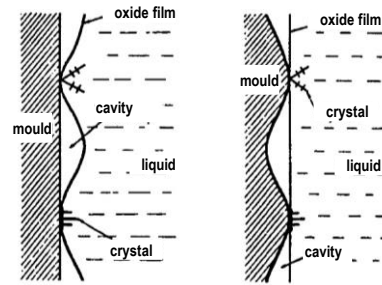
- [1] A. Ohno, The Solidification of Metals, Chijin Shokan Co. Ltd., 1976
- [2] P. Beeley, Foundry Technology, Butterworth-Heinemann, 2001

Topics to discuss today

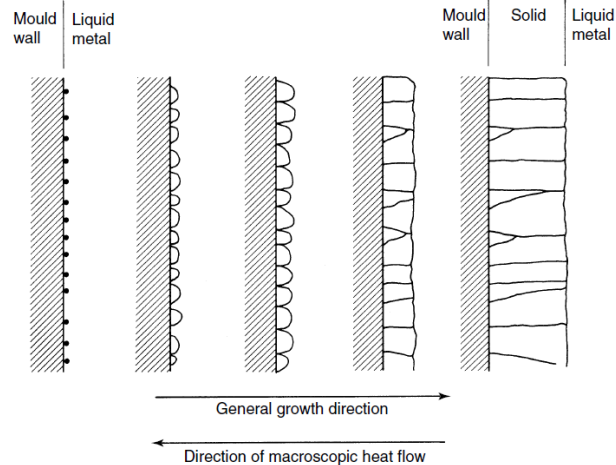
1. Solidification of pure metals
2. Depression of undercooling
3. Freezing of impure metals and alloys
4. The structure of casting

Review of earlier class

- ❑ Solid most readily nucleates heterogeneously on pre-existing surfaces having good metallic properties (i.e., wetted by the liquid).
- ❑ Since undercooling is the maximum at the mould wall, solid crystal is always nucleated randomly at the mould wall and form equiaxed chill zone.
- ❑ A nucleus makes contact with the pre-existing surface in many ways, causing different growth directions for different nucleus.
- ❑ Those nuclei having good contact with the mould wall will grow preferentially and form columnar crystals.



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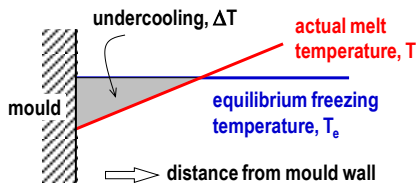
development of columnar grain structures

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1. Solidification of pure metals

- Immediately after pouring of liquid metal into the mould, a temperature gradient or, **undercooling**, ΔT , is developed in the melt adjacent to the mould wall

this gradient decreases as time passes



undercooling ahead of the mould wall immediately after pouring

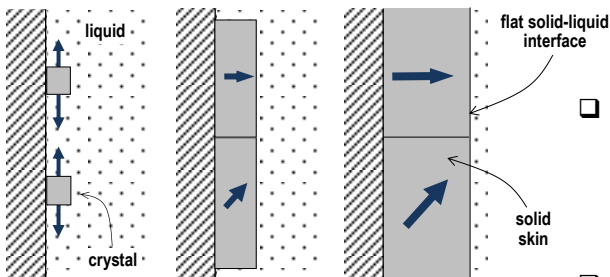
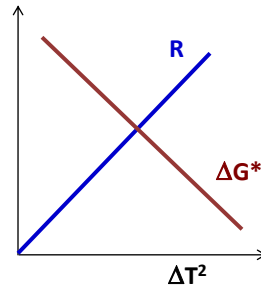
- For a mould with
 - wider wall thickness,
 - low temperature, and
 - high thermal conductivity
 the temperature gradient will be very steep in the liquid in front of the mould wall
- The largest amount of undercooling, ΔT , is expected in the liquid at the mould surface

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- The mean growth rate, R , of a nucleus is proportional to the square of the degree of undercooling:

$$R \propto \Delta T^2$$

- So a crystal nucleated at the mould wall grow first **along the mould surface** until it comes in contact with adjacent crystals that are also growing along the mould surface.



crystal growth of a pure metal on the mould wall

- A **solid skin** is thus formed, which then grows perpendicular to the mould wall in a stable manner with a **smooth/flat solid/liquid interface**.
- This is called the **planer mode of solidification**.

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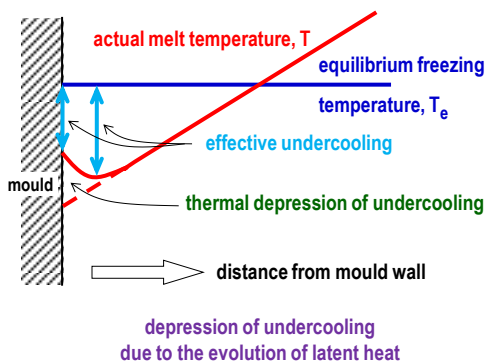
- ❑ A clean pure metal always solidifies in a **planer mode**.

- ❑ Such planer mode of solidification of pure metals can be altered when the liquid is contaminated due to the
 - absorption of gases
 - reaction between crucible/mould materials
 - presence of impurities or alloys

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2. Depression of undercooling

- ❑ When crystal grows, **latent heat** is evolved due to liquid \rightarrow solid transformation
 - this may raise the actual temperature of nearby liquid and reduce or **depress** the degree of undercooling ΔT at the liquid-solid interface



- ❑ Because of this **thermal depression of undercooling**, ΔT_{\max} occurs, not at the solid-liquid interface, but at a distance from the mould wall inside the liquid.

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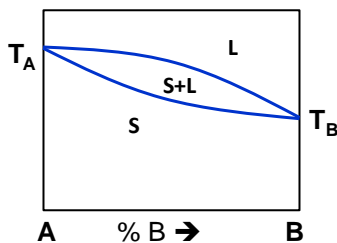
- ❑ For impure metals and alloys, a **variation in composition** of liquid in contact of solid/liquid interface with that of the bulk liquid occurs because of the segregation of solute atoms.

- the time of solidification may not be enough to homogenize the composition by diffusing solute atoms inside the liquid.

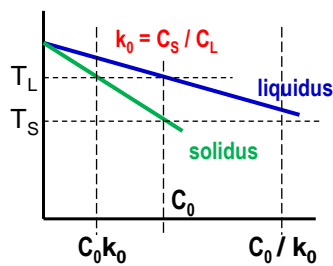
- ❑ This variation in composition of liquid ahead of the interface can also result a decrease in undercooling.

- this is referred to as **compositional depression of undercooling**.
- in some textbook, this compositional depression of undercooling is often termed as **constitutional supercooling**.

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isomorphous phase diagram



$k_0 =$ equilibrium distribution coefficient

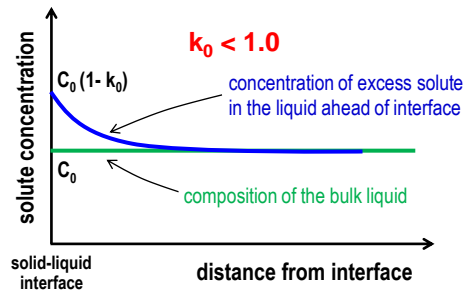
$$= \frac{\text{concentration of solute in solid, } C_S}{\text{concentration of solute in liquid, } C_L}$$

$k_0 < 1$, when an addition of solute lowers the liquidus temperature of the solvent (for $k_0 > 1$, the reverse is true)

- ❑ When a liquid with solute concentration C_0 is cooled to the temperature T , the first solid formed will contain solute of composition $C_0 k_0$.
- ❑ As $k_0 < 1$, the solid contains a lesser amount of solute than the bulk.
- ❑ The excess solute $C_0(1 - k_0)$ will be rejected or segregated at the advancing solid/liquid interface.

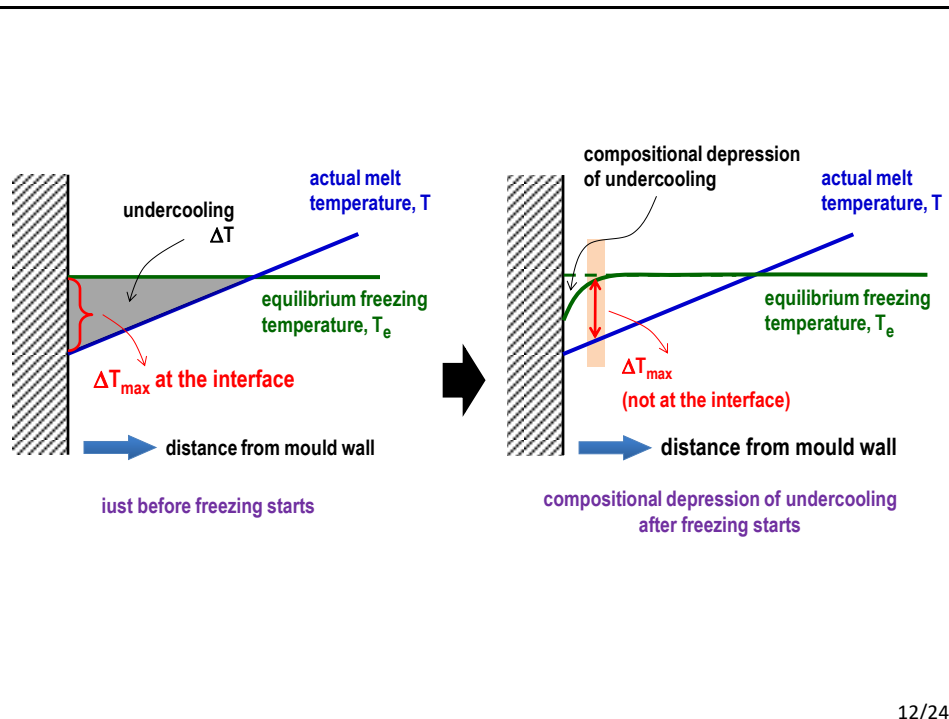
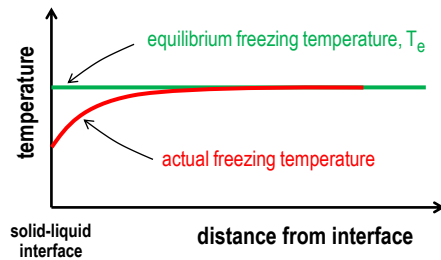
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- If there is not enough time for solute diffusion, the solute concentration at the solid/liquid interface would be higher than in the remaining bulk.



- This segregation of solute at the interface will cause a decrease in the equilibrium freezing point of the liquid at the interface.

this effectively results a decrease in the degree of undercooling at the interface



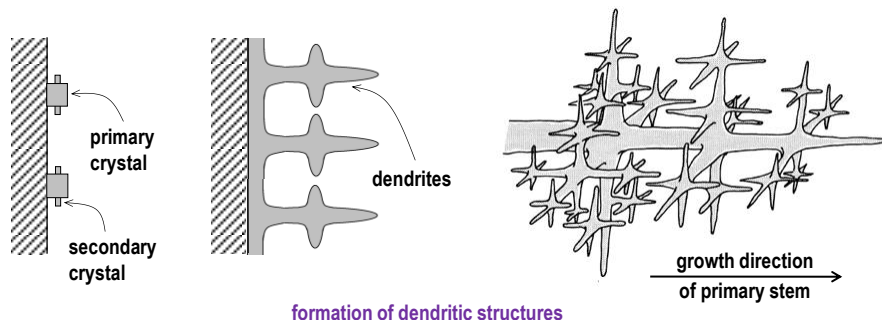
Consequence of depression of undercooling

- ❑ Because of these thermal and/or compositional **depressions of undercooling** growth of crystal at the liquid/solid interface will be prevented.
- ❑ Freezing will now continue/initiate away from the interface inside a band of liquid where undercooling is the maximum.
- ❑ Interaction of temperature with compositional gradient in liquid is thus regarded as **the single most important factor** that influence the structure of a casting.

Both grain and substructure depend upon this factor.

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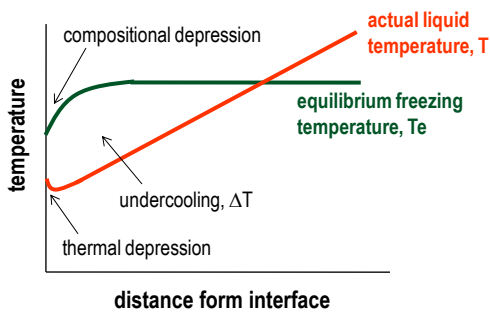
- ❑ When undercooling occurs in a band of liquid ahead of the interface, any protrusion / perturbation / bump at the face of primary crystal becomes stable and acts as the **centre for preferential growth**.
- ❑ These growth centres probe further into the zone of undercooling and developed as secondary arms of the primary crystals.
- ❑ Thus, a tree-like structures, call the **dendrites**, are formed. Solidification of this type is called **dendritic mode of solidification**.



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3. Freezing of impure metals and alloy

- The undercooling at the solid/liquid interface for impure metals and alloys can be depressed by both thermal and compositional methods.



depression of undercooling in the liquid ahead of interface for impure metals and alloys

- Because of high heat conductivity of metals and alloys, thermal depression of undercooling is always smaller than the compositional depression of undercooling.
- In pure metals, compositional depression does not occur and thermal depression of undercooling is also very small. Thus, dendritic mode of solidification in pure metals is limited.
- Because of both types of depression, the growth morphologies of impure metals and alloys are complex.

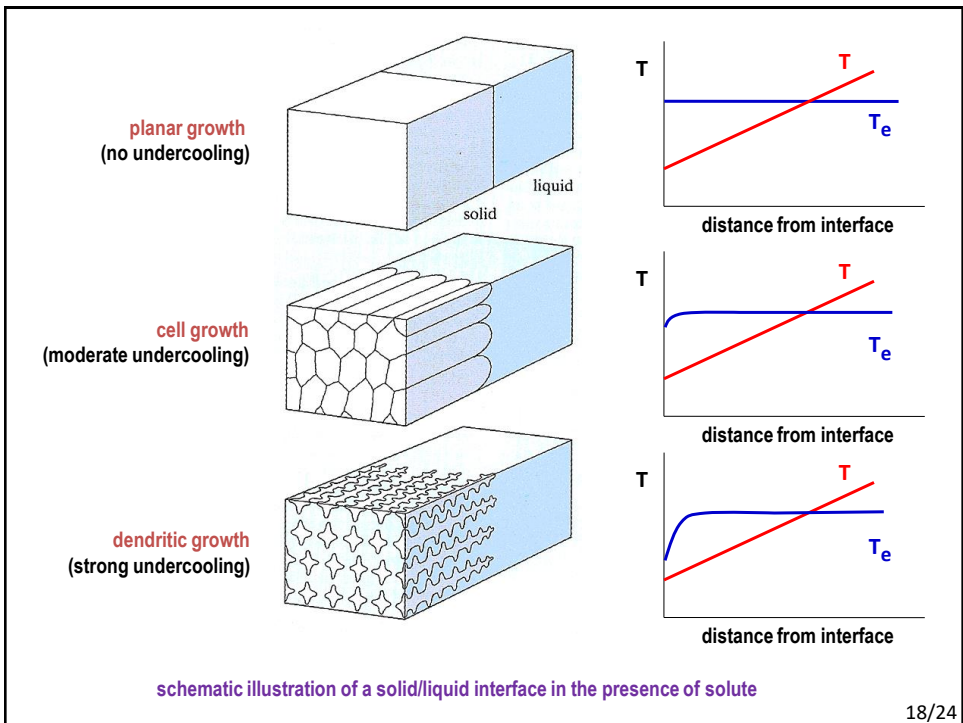
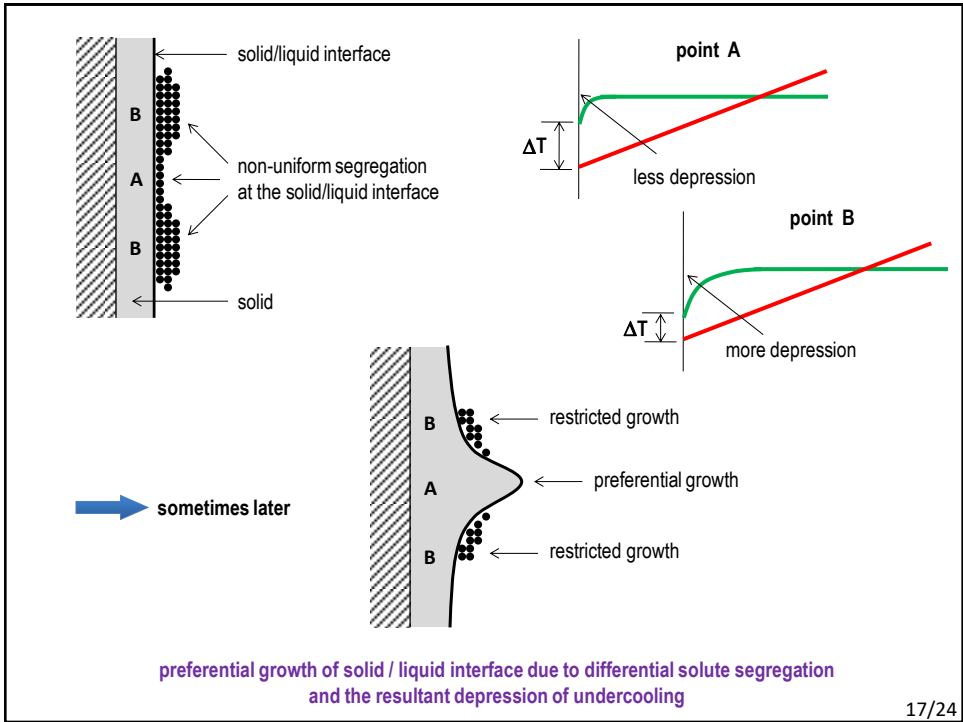
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- The rates of growth of crystals at the mould wall are different due to many factors (e.g., favourable growth direction, wettability, non-uniform mould wall, etc.)

rates of segregation of solute will also be different in different areas of the interface

- As a result, local areas of interface where segregation is the smallest (and thus ΔT is the largest) will grow preferentially.

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To summarise :

- ❑ A pure, clean melt always solidifies in planer mode.
- ❑ When a metal contains a small amount of solute, the projections that preferentially grow may develop in a non-equilibrium manner.
- ❑ As the solute concentration increases, the plain and smooth shape solid/liquid interface of pure metal will progressively develop into more extreme morphologies, termed node, cells and dendrites.

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4. The Structure of Casting

- ❑ So we have seen that **metal composition** (characterized by particular distribution and diffusion coefficients for solute in liquid and solid phases, which establish the relative tendency to depression of undercooling) governs the basic mode of crystallisation.
- ❑ Besides solute concentration, the structure of solid/liquid interface is also influenced by the **freezing rate** and **convection in liquid** in the front of the interface.
 - faster freezing rate → decreases the diffusion time for segregated solutes
 - faster convection in liquid → promotes atom movement

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- If the solid-liquid front moves forward by d to from a solute layer in time t , then the freezing rate $R = d/t$.

- Similar to all diffusion-controlled process, we then have:

$$d = (Dt)^{1/2} \quad D = \text{diffusion coefficient of solute in the liquid}$$

$$d = D/R$$

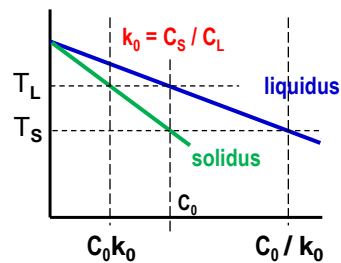
- Now the compositional depression of undercooling will occur when the temperature gradient, G , in the liquid at the front is:

$$G \leq - \frac{T_L - T_S}{d}$$

$$G/R \leq - (T_L - T_S)/D$$

$$G/R \leq - \frac{m C_0 (1 - k)}{kD}$$

$$m = \text{slope of liquidus line} = (T_L - T_S) / (C_0/k - C_0)$$



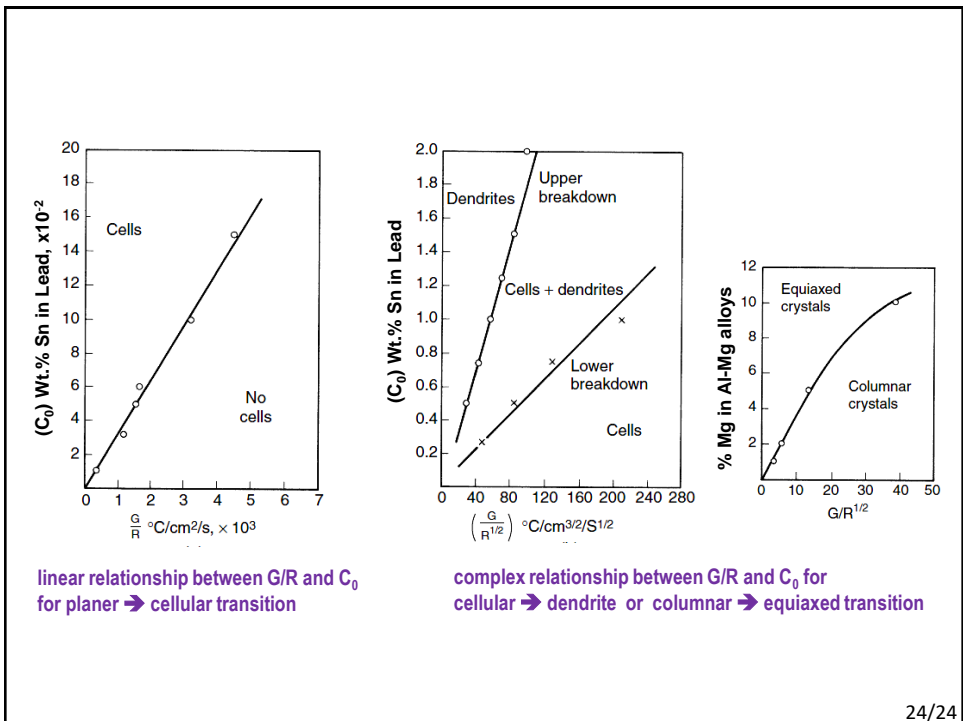
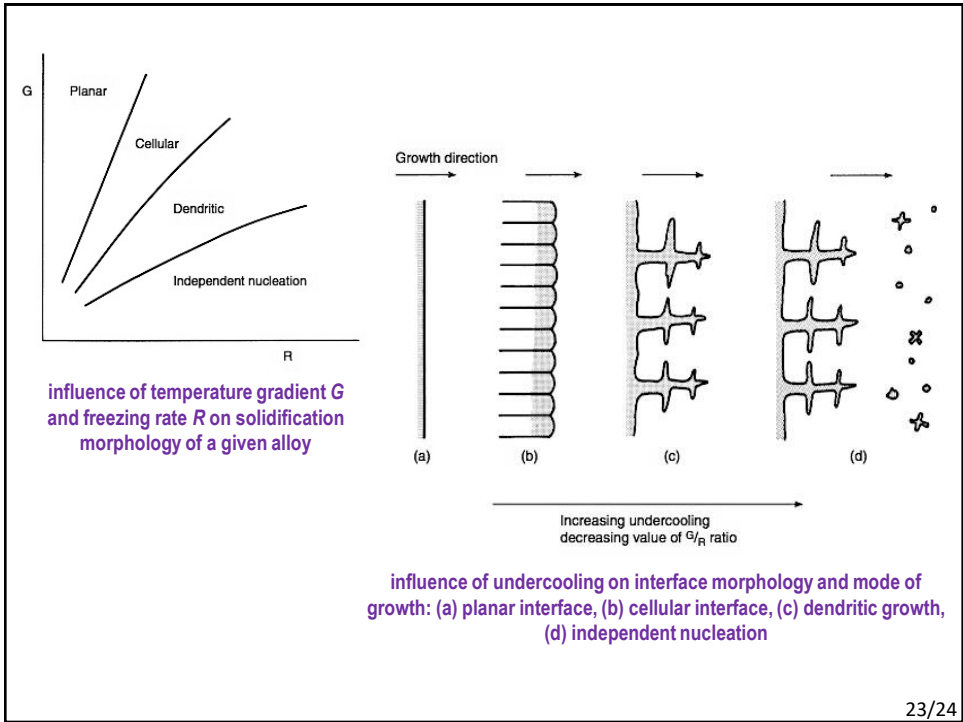
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Influence of G/R ratio

which assesses the compositional depression of undercooling

- Progressive change in the parameter G/R from a high to a low value is accompanied by **successive transitions in the mode of crystallization** as the effect of undercooling becomes more pronounced.
 - With a very high G/R ratio, columnar growth takes place with the advance of a plane interface, which first gives way to the cellular growth form as G/R ratio is decreased.
 - Further diminishing values of G/R bring about the cell-dendrite transition, with columnar growth now occurring on probes of solid some distance ahead of the main interface.
 - At still lower values of G/R , homogeneous independent nucleation in the undercooled zone brings about the growth of new grains in positions remote from the existing interface.

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Next Class

MME 345, Lecture B:05

Solidification and Crystallisation

4. Formation of dendrites